Si9934DY

SEMICONDUCTOR IM

Dual P-Channel 2.5V Specified PowerTrench[®] MOSFET

General Description

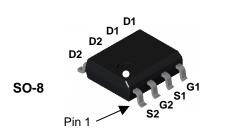
This P-Channel 2.5V specified MOSFET is a rugged gate version of Fairchild Semiconductor's advanced PowerTrench process. It has been optimized for power management applications with a wide range of gate drive voltage (2.5V - 12V).

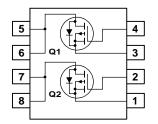
Applications

- Load switch
- Motor drive
- DC/DC conversion
- Power management

Features

- -5 A, -20 V, $R_{DS(ON)} = 50 \text{ m}\Omega @ V_{GS} = -4.5 \text{ V}$ $R_{DS(ON)} = 74 \text{ m}\Omega @ V_{GS} = -2.5 \text{ V}$
- Extended V_{GSS} range (±12V) for battery applications
- Low gate charge
- High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$
- High power and current handling capability





Absolute Maximum Ratings TA=25°C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DSS}	Drain-Source Voltage			-20	V	
V _{GSS}	Gate-Source Voltage			±12	V	
ID	Drain Current – Continuous		(Note 1a)	-5	А	
		– Pulsed		-30		
P _D	Power Dissipation for Dual Operation			2	W	
	Power Dissipation for Single Operation		n (Note 1a)	1.6		
			(Note 1b)	1		
			(Note 1c)	0.9		
T_{J}, T_{STG}	Operating and Storage Junction Temperature Range			-55 to +175	°C	
Therma	I Charact	teristics				
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient (Note 1a)			78	°C/W	
R _{θJC}	Thermal Resistance, Junction-to-Case (Note 1)			40 °		
Packag	e Marking	g and Ordering I	nformation			
Device Marking		Device	Reel Size	Tape width	Quantity	
9934		Si9934DY	13"	12mm	2500 units	

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Si9934DY

teristics rain–Source Breakdown Voltage reakdown Voltage Temperature oefficient ero Gate Voltage Drain Current ate–Body Leakage, Forward	$V_{GS} = 0 \text{ V}, \text{ I}_D = -250 \mu\text{A}$ $I_D = -250 \mu\text{A}, \text{ Referenced to } 25^{\circ}\text{C}$ $V_{DS} = -16 \text{ V}, V_{GS} = 0 \text{ V}$	-20	-16		V mV/°C
reakdown Voltage Temperature oefficient ero Gate Voltage Drain Current	$I_D = -250 \ \mu\text{A}$, Referenced to 25°C	-20	-16		-
reakdown Voltage Temperature oefficient ero Gate Voltage Drain Current			-16		m\//ºC
	$V_{pc} = -16 V$ $V_{cc} = 0 V$		1		11107 0
ata Bady Laakaga Farward				-1	μΑ
ale-bouy Leakaye, Forwaru	$V_{GS} = -12 \text{ V}, \qquad V_{DS} = 0 \text{ V}$			-100	nA
ate–Body Leakage, Reverse	$V_{GS} = 12 \text{ V}, \qquad V_{DS} = 0 \text{ V}$			100	nA
teristics (Note 2)					
ate Threshold Voltage	$V_{\text{DS}} = V_{\text{GS}}, \ I_{\text{D}} = -250 \ \mu\text{A}$	-0.6	-1.0	-1.5	V
ate Threshold Voltage emperature Coefficient	$I_D = -250 \ \mu\text{A}$, Referenced to 25°C		3		mV/°C
tatic Drain–Source n–Resistance	$V_{GS} = -2.5 V$, $I_D = -3 A$ $V_{GS} = -4.5 V$, $I_D = -5$, $T_J = 125^{\circ}C$		36 56 49	50 74 80	mΩ
n–State Drain Current	$V_{GS} = -4.5 \text{ V}, \qquad V_{DS} = -5 \text{ V}$	-15			A
orward Transconductance	$V_{\text{DS}} = -5 \text{ V}, \qquad I_{\text{D}} = -5 \text{ A}$		13		S
haracteristics					
put Capacitance			1015	1	pF
utput Capacitance			446		pF
everse Transfer Capacitance	f = 1.0 MHz		118	1	pF
Charactaristics (Note 2)			1	1	
	$V_{DD} = -5 V.$ $I_D = -1 A,$	<u> </u>	11	20	ns
urn-On Rise Time	$V_{GS} = -4.5 \text{ V}, R_{GEN} = 6 \Omega$			-	ns
	-		-	-	ns
	-		-		ns
	$V_{DS} = -5 V$, $I_D = -5 A$,		• ·		nC
	$V_{GS} = -4.5 V$		2.2		nC
8	4				nC
•	L Marcine Datione		<u> </u>		1.0
		T	<u> </u>	13	<u>م</u>
			0.7		A
oltage	$V_{GS} = 0$ V, $I_S = -1.3$ A (Note 2)		-0.7	-1.2	v
	teristics (Note 2) ate Threshold Voltage and Threshold Voltage n-Resistance n-Resistance n-Resistance n-Resistance n-Resistance n-Resistance n-Acteristics put Capacitance utput Capacitance characteristics (Note 2) urn-On Delay Time urn-On Rise Time urn-Off Delay Time urn-Off Fall Time otal Gate Charge ate-Drain Charge rce Diode Characteristics aximum Continuous Drain-Source rain-Source Diode Forward oltage	teristics(Note 2)ate Threshold Voltage $V_{DS} = V_{GS}$, $I_D = -250 \ \mu$ Aate Threshold Voltage $I_D = -250 \ \mu$ A, Referenced to 25°Cemperature Coefficient $I_D = -250 \ \mu$ A, Referenced to 25°Cattic Drain–Source $V_{GS} = -4.5 \ V$, $I_D = -5 \ A$ n–Resistance $V_{GS} = -4.5 \ V$, $I_D = -5 \ A$ vGs = -4.5 V, $I_D = -5 \ V$, $V_{DS} = -5 \ V$ n–State Drain Current $V_{GS} = -4.5 \ V$, $V_{DS} = -5 \ V$ put Capacitance $V_{DS} = -5 \ V$, $I_D = -5 \ A$ utput Capacitance $V_{DS} = -10 \ V$, $V_{GS} = 0 \ V$,terese Transfer Capacitance $V_{DS} = -10 \ V$, $V_{GS} = 0 \ V$,um–On Delay Time $V_{DD} = -5 \ V$, $I_D = -1 \ A$,um–On Rise Time $V_{DS} = -4.5 \ V$, $I_D = -1 \ A$,um–Off Delay Time $V_{DS} = -5 \ V$, $I_D = -5 \ A$ um–Off Fall Time $V_{DS} = -5 \ V$, $I_D = -5 \ A$,vGs = -4.5 V $V_{GS} = -4.5 \ V$ ate-Source Charge $V_{GS} = -4.5 \ V$ ate-Drain Charge $V_{GS} = -4.5 \ V$ rce Diode Characteristics and Maximum Ratingsaximum Continuous Drain–Source Diode Forward Currentrain–Source Diode Forward $V_{GS} = 0 \ V$, $I_S = -1.3 \ A$ (Note 2)	teristics (Note 2)ate Threshold Voltage $V_{DS} = V_{GS}$, $I_D = -250 \ \mu$ A -0.6 ate Threshold Voltage $I_D = -250 \ \mu$ A, Referenced to 25° Cemperature Coefficient $I_D = -250 \ \mu$ A, Referenced to 25° Ctatic Drain–Source $V_{GS} = -4.5 \ V$, $I_D = -5 \ A$ n–Resistance $V_{GS} = -4.5 \ V$, $I_D = -5 \ A$ n–State Drain Current $V_{GS} = -4.5 \ V$, $I_D = -5 \ V$ n–State Drain Current $V_{GS} = -4.5 \ V$, $V_{DS} = -5 \ V$ n–State Drain Current $V_{GS} = -4.5 \ V$, $I_D = -5 \ A$ m–State Drain Current $V_{GS} = -4.5 \ V$, $I_D = -5 \ A$ m–State Drain Current $V_{DS} = -5 \ V$, $I_D = -5 \ A$ m–State Drain Current $V_{DS} = -5 \ V$, $I_D = -5 \ A$ m–State Drain ce $V_{DS} = -10 \ V$, $V_{GS} = 0 \ V$,tuput Capacitance $V_{DS} = -10 \ V$, $V_{GS} = 0 \ V$,everse Transfer Capacitance $V_{DD} = -5 \ V$, $I_D = -1 \ A$,urn–On Delay Time $V_{DS} = -5 \ V$, $I_D = -1 \ A$,urn–On Rise Time $V_{DS} = -5 \ V$, $I_D = -5 \ A$,urn–Off Delay Time $V_{DS} = -5 \ V$, $I_D = -5 \ A$,urn–Off Fall Time $V_{GS} = -4.5 \ V$ ate–Drain Charge $V_{GS} = -4.5 \ V$ ate–Drain Charge $V_{GS} = 0 \ V$, $I_S = -1.3 \ A$ (Note 2)atimum Continuous Drain–Source Diode Forward Current $I_{S} = -1.3 \ A$ (Note 2)othage $V_{GS} = 0 \ V$, $I_S = -1.3 \ A$ (Note 2)	teristics (Note 2)ate Threshold Voltage $V_{DS} = V_{GS}$, $I_D = -250 \ \mu$ A, Referenced to 25° C3ate Threshold Voltage $I_D = -250 \ \mu$ A, Referenced to 25° C3ate Threshold Voltage $I_D = -250 \ \mu$ A, Referenced to 25° C3ate Threshold Voltage $V_{GS} = -4.5 \ V$, $I_D = -5 \ A$ 36n-Resistance $V_{GS} = -4.5 \ V$, $I_D = -5 \ A$ 56 $V_{GS} = -4.5 \ V$, $I_D = -5 \ A$ 56 $V_{GS} = -4.5 \ V$, $I_D = -5 \ A$ 13haracteristics $V_{DS} = -5 \ V$, $I_D = -5 \ A$ 13haracteristics $V_{DS} = -10 \ V$, $V_{GS} = 0 \ V$, $I_D = -5 \ A$ 1015uput Capacitance $V_{DS} = -10 \ V$, $V_{GS} = 0 \ V$, $I_D = -1 \ A$, $I_D = -10 \ V$, $V_{GS} = 0 \ V$, $I_D = -10 \ V$, $V_{GS} = -10 \ V$, $V_{GS} = 0 \ V$, $I_D = -10 \ V$, $V_{GS} = 0 \ V$, $I_D = -5 \ A$ 118Characteristics (Note 2)urn-On Delay Time $V_{DD} = -5 \ V$, $I_D = -5 \ A$, $I_D = -5 \ A$, $I_D = -10 \ V$, $V_{GS} = -4.5 \ V$, $R_{GEN} = 6 \ \Omega$ 18urn-On Rise Time $V_{DS} = -5 \ V$, $I_D = -5 \ A$,	teristics (Note 2)ate Threshold Voltage $V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$ -0.6 -1.0 -1.5 ate Threshold Voltage emperature Coefficient $I_D = -250 \ \mu A$, Referenced to 25° C33ate Threshold Voltage emperature Coefficient $I_D = -250 \ \mu A$, Referenced to 25° C336ate Threshold Voltage emperature Coefficient $V_{GS} = -4.5 \ V$, $I_D = -5 \ A$ 3650n-Resistance $V_{GS} = -4.5 \ V$, $I_D = -5 \ A$ 3650n-State Drain Current $V_{GS} = -4.5 \ V$, $I_D = -5 \ V$ -15 $V_{GS} = -15 \ V$ put Capacitance $V_{DS} = -5 \ V$, $I_D = -5 \ A$ 13 $V_{DS} = -5 \ V$ put Capacitance $V_{DS} = -10 \ V$, $V_{GS} = 0 \ V$, f = $1.0 \ MHz$ $1015 \ V_{446}$ cerese Transfer Capacitance $V_{DS} = -5 \ V$, $I_D = -1 \ A$, $V_{GS} = -4.5 \ V$, $R_{GEN} = 6 \ \Omega$ 1822 $34 \ 555 \ 0 \ 0 \ 0 \ 0 \ 0 \ 0 \ 0 \ 0 \$

2. Pulse Test: Pulse Width < 300 μ s, Duty Cycle < 2.0%

Si9934DY Rev A(W)

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